

Engineering Ferroelectricity and Quadruple-well State in CulnP₂S₆ (CIPS) via Interfacial PbZr_{0.2}Ti_{0.8}O₃

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Abstract

The ferroelectric van der Waals CulnP₂S₆ (CIPS) possesses intriguing quadruple-well states and negative piezoelectricity. Its technological implementation has been impeded by the relatively low Curie temperature (bulk $T_{\rm C}$ ~42 °C) and the lack of precise domain control. Here we show that enhanced ferroelectricity and piezoelectricity as well as controlled domain formation can be achieved in thin CIPS flakes by interfacing with ferroelectric PbZr_{0.2}Ti_{0.8}O₃ (PZT) films. Piezoresponse force microscopy (PFM) studies show that the polar domains in CIPS fully conform to those of underlying PZT as the flake thickness is reduced below 25 nm. The enhanced polar alignment is accompanied by a sign change in the piezoelectric coefficient d_{33} . In situ PFM studies reveal an enhanced $T_{\rm C}$ of ~200 °C in thin CIPS. Density functional theory modeling of CIPS/PbTiO₃ reveals the critical role of interface-modulated lattice distortion, which can facilitate polar alignment in CIPS. Monte Carlo simulations show that this effect also quantitatively accounts for the enhanced $T_{\rm C}$ in CIPS. Our study provides a new material strategy for engineering the polar properties of ultrathin CIPS for developing nanoelectronic, mechanical, and energy applications.

Technical Approach

Interfacing CIPS with a ferroelectric layer



PZT

- Write domain patterns on PZT using conductive probe AFM
- Mechanical exfoliation of CIPS flakes
- Dry transfer of 6-300 nm flakes on PZT with prepatterned domain structure
- Control studies: CIPS flakes prepared on doped Si and Au

PFM Characterization

Domain Formation in 14 nm CIPS on Different Substrates





> Quantifying d_{33}^{CIPS} (e.g., 14 nm CIPS)

Off-resonance PFM Voltage across CIPS/PZT **Finite Element Analysis** 1.0 CIP CIP S/Si S/PZ Amp. (mV) 1 (... (a.u.) (... $v_{cIPS} = 74.4\%$ S/Au 20 80 2 60 $V_{\rm bias}$ (V) Depth (nm) Polarization of CIPS and PZT antialigned $d_{33}^{\text{tot}} =$ $d_{33}^{\text{tot}} = v_{\text{PZT}} \cdot d_{33}^{\text{PZT}} - v_{\text{CIPS}} \cdot d_{33}^{\text{CIPS}}$

Analysis of d_{33}^{CIPS}

\succ Thickness Dependence of d_{33}^{CIPS}



Motivation

Ferroelectricity and piezoelectricity



Large bandgap: ~2.9 eV • Out-of-plane polarization: ~4 μ C/cm² • Negative piezoelectric coefficient d_{33}

Quadruple-energy Well



- Ground state (GS): intralayer displacement leads to negative d_{33}
- Metastable state (MS): interlayer displacement leads to positive d_{33}

Potential Applications





180°



- > CIPS on P_{up} domain of CIPS on doped Si and Au: spontaneous PZT: uniform PFM phase consistent with that of PZT
- Effect of CIPS Thickness on Interface Synergy between CIPS and PZT





Evolution of domain structure in CIPS with flake thickness

formation of P_{up} and P_{down} domains

- 13 nm: Domain pattern conforms to that of underlying PZT
- 55 nm: Randomly distributed P_{up} and $P_{\rm down}$ domains start to emerge
- 70 nm and thicker: Predominantly $P_{\rm up}$, regardless of the polarizations of underlying PZT
- The synergy between CIPS and PZT decays with CIPS thickness, suggesting that it is an interfacial effect

	15 10		1	 CIPS/ CIPS/ 	/PZT /Si	CIPS on Si and Au
d ^{CIPS} (pm/V)	5-	¢ ∳∆∑		CIPS/	Au	 d^{CIPS}₃₃ for CIPS on PZT:
	0	₽́S		d ₃₃ > (0 (MS)	I : negative d_{33}^{CIPS}
	-5	○ ○ _⊥ ∑		d ₃₃ < 0	0 (GS)	II: transition region
	-10	Q ⊼∑∳	§ ∘ [∑] I	∞ بې بې	•	III: positive d_{33}^{CIPS}
	-15	ΥY				Enhanced d ^{CIPS} in thin
	-20			······································		CIPS on PZT
	0 50 100 150 300 CIPS Thickness (nm)					
> Mechanism for the sign change in d_{33}^{CIPS}						
	CIPS (P_{up}) on PTO (P_{down})					Asymmetric profile
						∱ Energy
		0=	A	Lattice		-MS -GS +GS

- B Cu position
- Interfacial lattice distortion tilts the quadruple well Energy barrier to MS ($d_{33} > 0$) is suppressed in region III

Enhanced T_c for CIPS on PZT

In-situ PFM of CIPS/PZT



150 300 450 600 750





- ✓ Precise domain control \Rightarrow high density of polarization-enabled devices
- ✓ High $T_{\rm C}$ ⇒ high thermal stability

> Challenges

> Diffusive, rough domain walls in domain writing due to high Cu ion mobility



Pristine domain Written domain

\succ Relatively low $T_{\rm C}$ impedes room-temperature application

Our goal: Develop a strategy to achieve controlled domain formation and enhanced $T_{\rm C}$ in CIPS



The antialigned configuration has lower energy

- Higher lattice distortion in the aligned polarization state leads to higher elastic energy cost
- Polarization antialignment is preferred, consistent with experimental observation



 Stripe domains in CIPS disappear at 225 °C (~ $T_{\rm C}$)

T (K) MC simulation reveals enhanced $T_{\rm C} \sim 650$ K for CIPS on PTO, agreeing with the experimental result

Conclusion

- Domain formation in thin CIPS (< 25 nm) conforms to that in the underlying PZT
- Thin CIPS on PZT exhibits enhanced d_{33}^{CIPS} accompanied with a sign change, and $T_{\rm C}$ is enhanced by 55%
- DFT modeling reveals interfacial lattice distortion that modifies the energy profile, which can account for the enhanced ferroelectricity and piezoelectricity in CIPS

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